

4

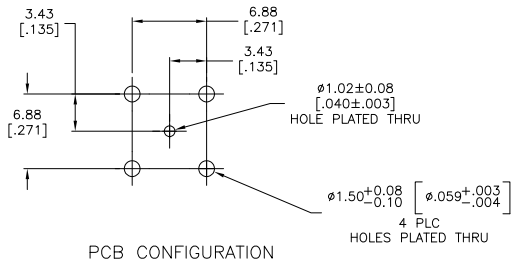
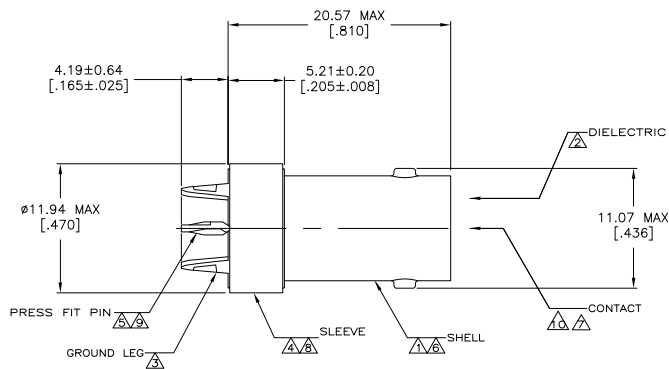
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LOC	QTY	REV	DESCRIPTION	DATE	BY	APP'D
AJ	00	N	REV PER ECO 07-002853	21MAR2007	DW	JL



- 1 ZINC PER QQ-Z-363.
- 2 PTFE PER MIL-P-19468.
- 3 COPPER-IRON ALLOY PER ASTM-B-465.
- 4 COPPER PER QQ-C-576.
- 5 COPPER-NICKEL ALLOY PER ASTM-B-122.
- 6 NICKEL PLATE PER QQ-N-290
3.81 μm [0.000150] MINIMUM THICK.
- 7 GOLD PLATE PER MIL-G-45204
0.76 μm [0.000030] MINIMUM THICK.
- 8 TIN PLATE PER ASTM-B-545,
2.54 μm [0.000100] MIN THICK.
- 9 GOLD PLATE PER MIL-G-45204
- 10 BERYLLIUM COPPER PER ASTM-B-643
- 11 .010±.001 THICK, MYLAR (POLYESTER FILM) INSULATOR, AMP P/N 1274912-1, ATTACHED TO BOTTOM, (NOT SHOWN).
- 12 TIN-LEAD PLATE PER ASTM-B-545,
2.54 μm [0.000100] MIN THICK.

13. CONNECTOR PRESS FIT IS DESIGNED TO PROVIDE 100 LB. MINIMUM AXIAL RETENTION TO PCB COMPLIANT WITH TYCO APPLICATION SPEC 114-12001. AS A RESULT, DEFORMATION OF PLATED THROUGH HOLES WILL OCCUR. CUSTOMER VALIDATION AND ACCEPTANCE OF THIS DEFORMATION IS RECOMMENDED PRIOR TO SPECIFYING USE OF THIS PRODUCT.

OBSELETE	9-222462-0
222462-4	
222462-2	
222462-1	
GROUND LEG	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		BY J. LIPPERT	DATE 8-2-93	Tyco Electronics Corporation Harrisburg, PA 17105-3608
DIMENSIONS: mm [INCHES]		CHK D. TAYLOR	DATE 8-5-93	
0 PLC ± - 1 PLC ± - 2 PLC ± 0.05 [0.002] 3 PLC ± - 4 PLC ± - ANGLES ± -		BY J. LIPPERT	DATE 8-5-93	JACK, PCB, HIGH RETENTION PRESS FIT, 75 OHM, BNC
MATERIAL FINISH		PRODUCT SPEC 108-12103	APPLICATION SPEC 114-12001	
1 THRU 5,10,11		CUSTOMER DRAWING		SIZE CASE CODE DRAWING NO A2 00779 C-222462
6 THRU 10,12		SCALE 5:1		RESTRICTED TO -
		SHEET 1 of 1		REV N

AMP 1471-9 REV 31MM2000

222462

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